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#### Details

Product Status	Active
Core Processor	S08
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, I <sup>2</sup> C, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	53
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/pro/item?MUrl=&amp;PartUrl=mc9s08dv32mlh">https://www.e-xfl.com/pro/item?MUrl=&amp;PartUrl=mc9s08dv32mlh</a>

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<sup>1</sup> ACMP20 is not available.

## 1.2 MCU Block Diagram

Figure 1-1 is the MC9S08DV60 Series system-level block diagram.

### 6.5.4.7 Port D Interrupt Pin Select Register (PTDPS)

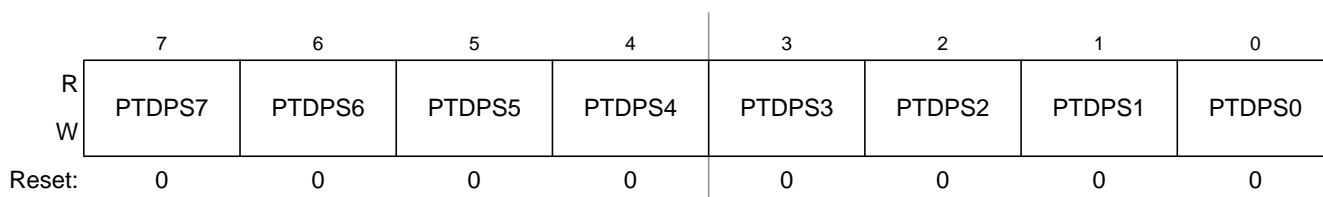


Figure 6-30. Port D Interrupt Pin Select Register (PTDPS)

Table 6-28. PTDPS Register Field Descriptions

Field	Description
7:0 PTDPS[7:0]	<b>Port D Interrupt Pin Selects</b> — Each of the PTDPSn bits enable the corresponding port D interrupt pin. 0 Pin not enabled as interrupt. 1 Pin enabled as interrupt.

### 6.5.4.8 Port D Interrupt Edge Select Register (PTDES)

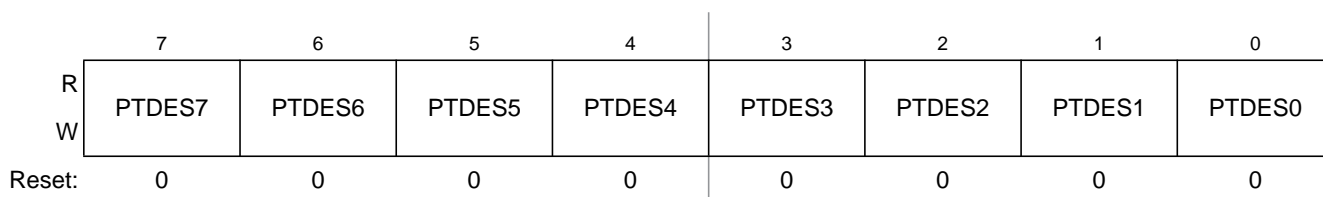
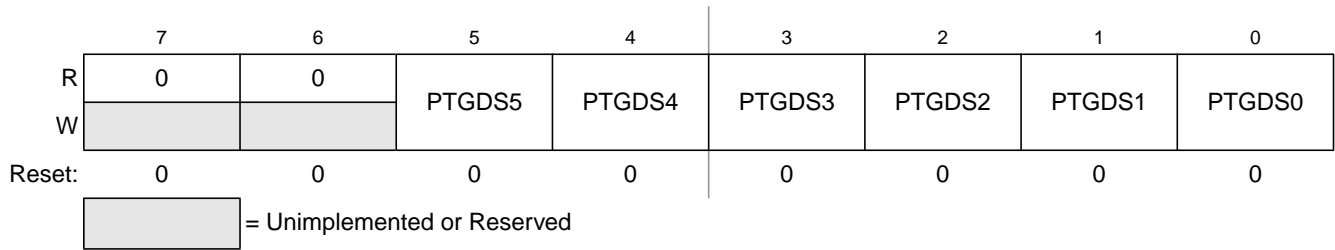


Figure 6-31. Port D Edge Select Register (PTDES)

Table 6-29. PTDES Register Field Descriptions

Field	Description
7:0 PTDES[7:0]	<b>Port D Edge Selects</b> — Each of the PTDESn bits serves a dual purpose by selecting the polarity of the active interrupt edge as well as selecting a pull-up or pull-down device if enabled. 0 A pull-up device is connected to the associated pin and detects falling edge/low level for interrupt generation. 1 A pull-down device is connected to the associated pin and detects rising edge/high level for interrupt generation.

### 6.5.7.5 Port G Drive Strength Selection Register (PTGDS)



**Figure 6-46. Drive Strength Selection for Port G Register (PTGDS)**

**Table 6-44. PTGDS Register Field Descriptions**

Field	Description
5:0 PTGDS[5:0]	<p><b>Output Drive Strength Selection for Port G Bits</b> — Each of these control bits selects between low and high output drive for the associated PTG pin. For port G pins that are configured as inputs, these bits have no effect.</p> <p>0 Low output drive strength selected for port G bit n.                      1 High output drive strength selected for port G bit n.</p>

## 7.2 Programmer's Model and CPU Registers

Figure 7-1 shows the five CPU registers. CPU registers are not part of the memory map.

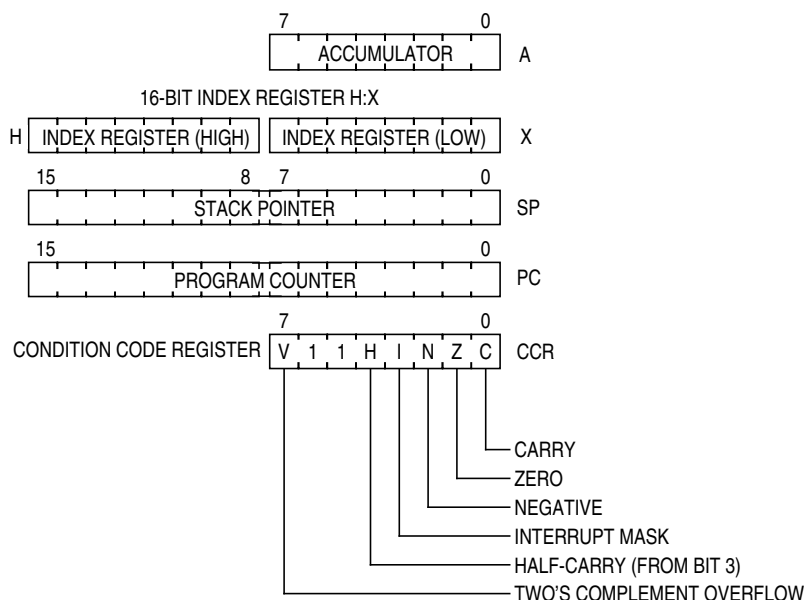


Figure 7-1. CPU Registers

### 7.2.1 Accumulator (A)

The A accumulator is a general-purpose 8-bit register. One operand input to the arithmetic logic unit (ALU) is connected to the accumulator and the ALU results are often stored into the A accumulator after arithmetic and logical operations. The accumulator can be loaded from memory using various addressing modes to specify the address where the loaded data comes from, or the contents of A can be stored to memory using various addressing modes to specify the address where data from A will be stored.

Reset has no effect on the contents of the A accumulator.

### 7.2.2 Index Register (H:X)

This 16-bit register is actually two separate 8-bit registers (H and X), which often work together as a 16-bit address pointer where H holds the upper byte of an address and X holds the lower byte of the address. All indexed addressing mode instructions use the full 16-bit value in H:X as an index reference pointer; however, for compatibility with the earlier M68HC05 Family, some instructions operate only on the low-order 8-bit half (X).

Many instructions treat X as a second general-purpose 8-bit register that can be used to hold 8-bit data values. X can be cleared, incremented, decremented, complemented, negated, shifted, or rotated. Transfer instructions allow data to be transferred from A or transferred to A where arithmetic and logical operations can then be performed.

For compatibility with the earlier M68HC05 Family, H is forced to 0x00 during reset. Reset has no effect on the contents of X.

### 8.3.2 MCG Control Register 2 (MCGC2)

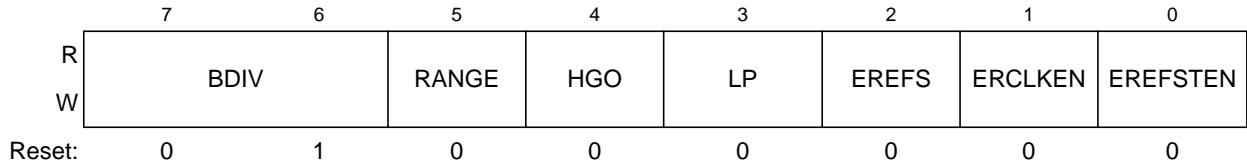


Figure 8-4. MCG Control Register 2 (MCGC2)

Table 8-2. MCG Control Register 2 Field Descriptions

Field	Description
7:6 BDIV	<p><b>Bus Frequency Divider</b> — Selects the amount to divide down the clock source selected by the CLKS bits in the MCGC1 register. This controls the bus frequency.</p> <p>00 Encoding 0 — Divides selected clock by 1                      01 Encoding 1 — Divides selected clock by 2 (reset default)                      10 Encoding 2 — Divides selected clock by 4                      11 Encoding 3 — Divides selected clock by 8</p>
5 RANGE	<p><b>Frequency Range Select</b> — Selects the frequency range for the external oscillator or external clock source.</p> <p>1 High frequency range selected for the external oscillator of 1 MHz to 16 MHz (1 MHz to 40 MHz for external clock source)                      0 Low frequency range selected for the external oscillator of 32 kHz to 100 kHz (32 kHz to 1 MHz for external clock source)</p>
4 HGO	<p><b>High Gain Oscillator Select</b> — Controls the external oscillator mode of operation.</p> <p>1 Configure external oscillator for high gain operation                      0 Configure external oscillator for low power operation</p>
3 LP	<p><b>Low Power Select</b> — Controls whether the FLL (or PLL) is disabled in bypassed modes.</p> <p>1 FLL (or PLL) is disabled in bypass modes (lower power).                      0 FLL (or PLL) is not disabled in bypass modes.</p>
2 EREFS	<p><b>External Reference Select</b> — Selects the source for the external reference clock.</p> <p>1 Oscillator requested                      0 External Clock Source requested</p>
1 ERCLKEN	<p><b>External Reference Enable</b> — Enables the external reference clock for use as MCGERCLK.</p> <p>1 MCGERCLK active                      0 MCGERCLK inactive</p>
0 EREFSTEN	<p><b>External Reference Stop Enable</b> — Controls whether or not the external reference clock remains enabled when the MCG enters stop mode.</p> <p>1 External reference clock stays enabled in stop if ERCLKEN is set or if MCG is in FEE, FBE, PEE, PBE, or BLPE mode before entering stop                      0 External reference clock is disabled in stop</p>





ALTCLK for this MCU. Consult the module introduction for information on ALTCLK specific to this MCU.

A conversion complete event sets the COCO and generates an ADC interrupt to wake the MCU from wait mode if the ADC interrupt is enabled ( $AIEN = 1$ ).

## 10.4.7 MCU Stop3 Mode Operation

Stop mode is a low power-consumption standby mode during which most or all clock sources on the MCU are disabled.

### 10.4.7.1 Stop3 Mode With ADACK Disabled

If the asynchronous clock, ADACK, is not selected as the conversion clock, executing a stop instruction aborts the current conversion and places the ADC in its idle state. The contents of ADCRH and ADCRL are unaffected by stop3 mode. After exiting from stop3 mode, a software or hardware trigger is required to resume conversions.

### 10.4.7.2 Stop3 Mode With ADACK Enabled

If ADACK is selected as the conversion clock, the ADC continues operation during stop3 mode. For guaranteed ADC operation, the MCU's voltage regulator must remain active during stop3 mode. Consult the module introduction for configuration information for this MCU.

If a conversion is in progress when the MCU enters stop3 mode, it continues until completion. Conversions can be initiated while the MCU is in stop3 mode by means of the hardware trigger or if continuous conversions are enabled.

A conversion complete event sets the COCO and generates an ADC interrupt to wake the MCU from stop3 mode if the ADC interrupt is enabled ( $AIEN = 1$ ).

#### NOTE

The ADC module can wake the system from low-power stop and cause the MCU to begin consuming run-level currents without generating a system level interrupt. To prevent this scenario, software should ensure the data transfer blocking mechanism (discussed in [Section 10.4.4.2, “Completing Conversions”](#)) is cleared when entering stop3 and continuing ADC conversions.

## 10.4.8 MCU Stop2 Mode Operation

The ADC module is automatically disabled when the MCU enters stop2 mode. All module registers contain their reset values following exit from stop2. Therefore, the module must be re-enabled and re-configured following exit from stop2.

### 11.1.3 Block Diagram

Figure 11-2 is a block diagram of the IIC.

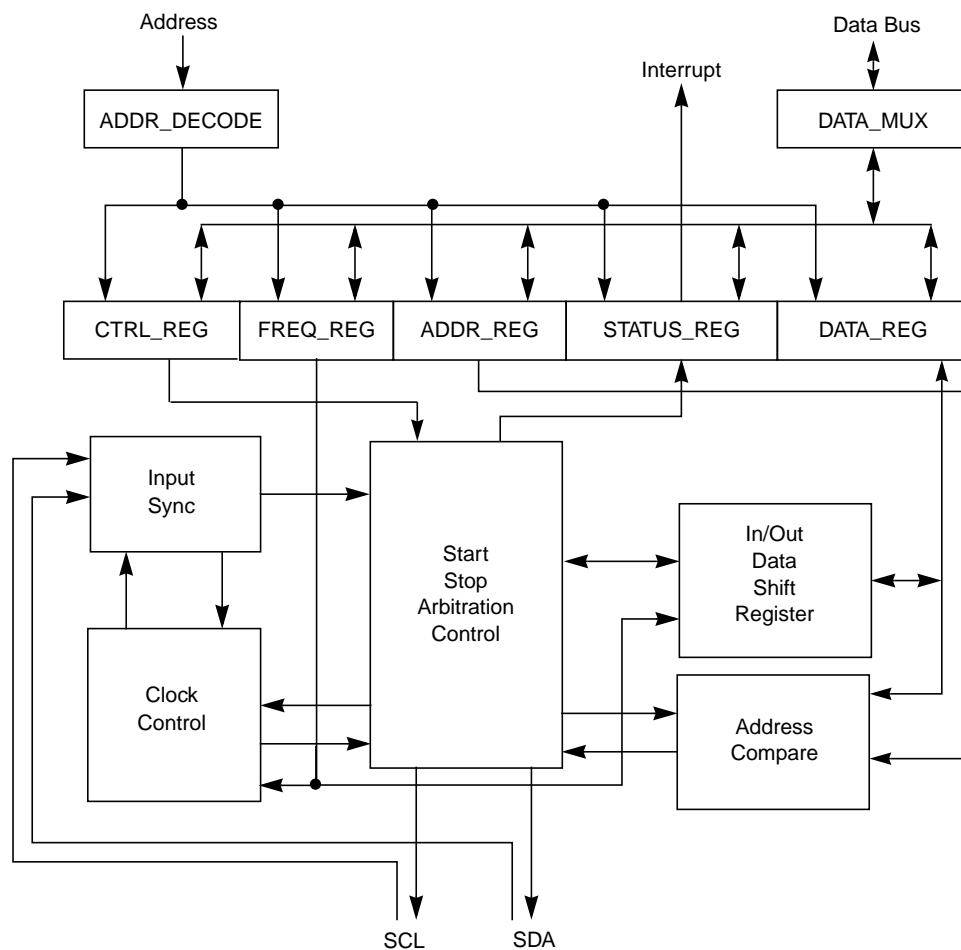


Figure 11-2. IIC Functional Block Diagram

## 11.2 External Signal Description

This section describes each user-accessible pin signal.

### 11.2.1 SCL — Serial Clock Line

The bidirectional SCL is the serial clock line of the IIC system.

### 11.2.2 SDA — Serial Data Line

The bidirectional SDA is the serial data line of the IIC system.

## 11.3 Register Definition

This section consists of the IIC register descriptions in address order.

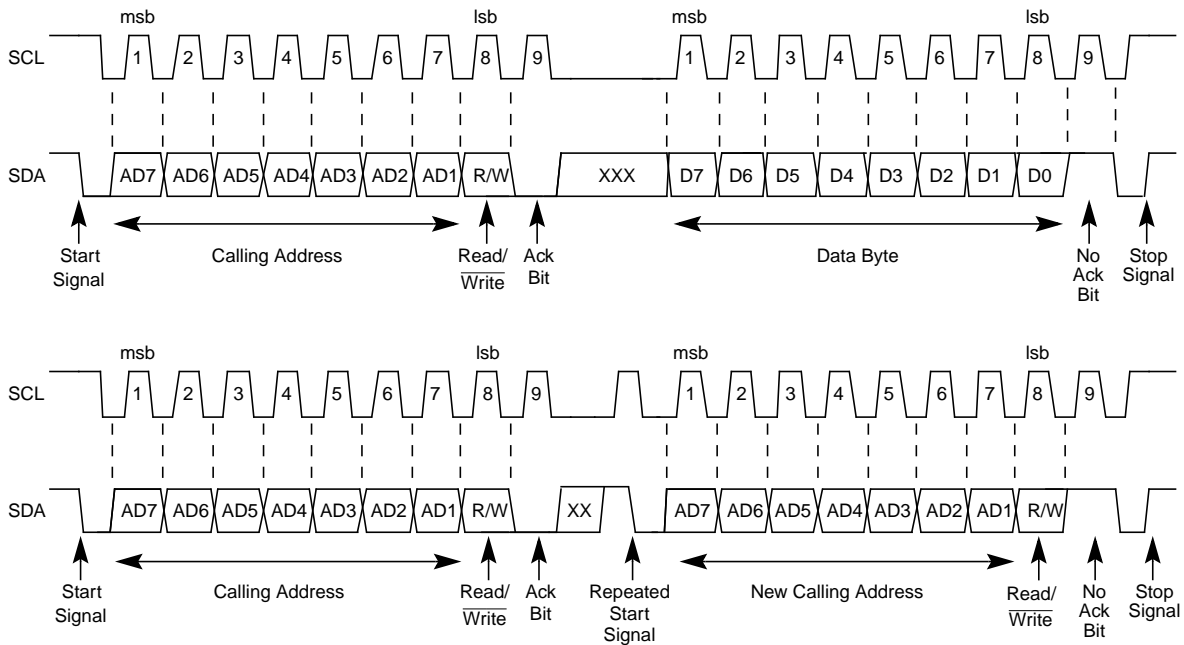


Figure 11-9. IIC Bus Transmission Signals

### 11.4.1.1 Start Signal

When the bus is free, no master device is engaging the bus (SCL and SDA lines are at logical high), a master may initiate communication by sending a start signal. As shown in Figure 11-9, a start signal is defined as a high-to-low transition of SDA while SCL is high. This signal denotes the beginning of a new data transfer (each data transfer may contain several bytes of data) and brings all slaves out of their idle states.

### 11.4.1.2 Slave Address Transmission

The first byte of data transferred immediately after the start signal is the slave address transmitted by the master. This is a seven-bit calling address followed by a  $R/\overline{W}$  bit. The  $R/\overline{W}$  bit tells the slave the desired direction of data transfer.

- 1 = Read transfer, the slave transmits data to the master.
- 0 = Write transfer, the master transmits data to the slave.

Only the slave with a calling address that matches the one transmitted by the master responds by sending back an acknowledge bit. This is done by pulling the SDA low at the ninth clock (see Figure 11-9).

No two slaves in the system may have the same address. If the IIC module is the master, it must not transmit an address equal to its own slave address. The IIC cannot be master and slave at the same time. However, if arbitration is lost during an address cycle, the IIC reverts to slave mode and operates correctly even if it is being addressed by another master.

the transition from master to slave mode does not generate a stop condition. Meanwhile, a status bit is set by hardware to indicate loss of arbitration.

### 11.4.1.7 Clock Synchronization

Because wire-AND logic is performed on the SCL line, a high-to-low transition on the SCL line affects all the devices connected on the bus. The devices start counting their low period and after a device's clock has gone low, it holds the SCL line low until the clock high state is reached. However, the change of low to high in this device clock may not change the state of the SCL line if another device clock is still within its low period. Therefore, synchronized clock SCL is held low by the device with the longest low period. Devices with shorter low periods enter a high wait state during this time (see Figure 11-10). When all devices concerned have counted off their low period, the synchronized clock SCL line is released and pulled high. There is then no difference between the device clocks and the state of the SCL line and all the devices start counting their high periods. The first device to complete its high period pulls the SCL line low again.

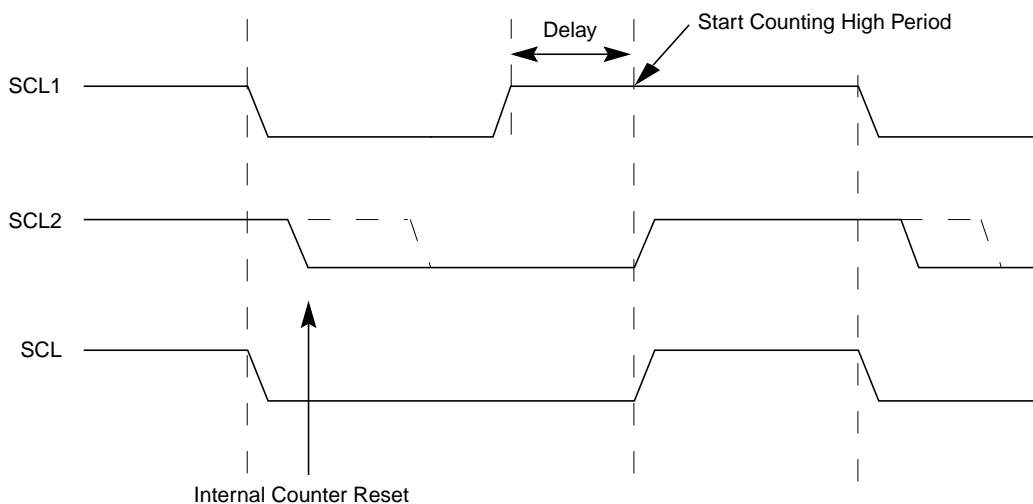


Figure 11-10. IIC Clock Synchronization

### 11.4.1.8 Handshaking

The clock synchronization mechanism can be used as a handshake in data transfer. Slave devices may hold the SCL low after completion of one byte transfer (9 bits). In such a case, it halts the bus clock and forces the master clock into wait states until the slave releases the SCL line.

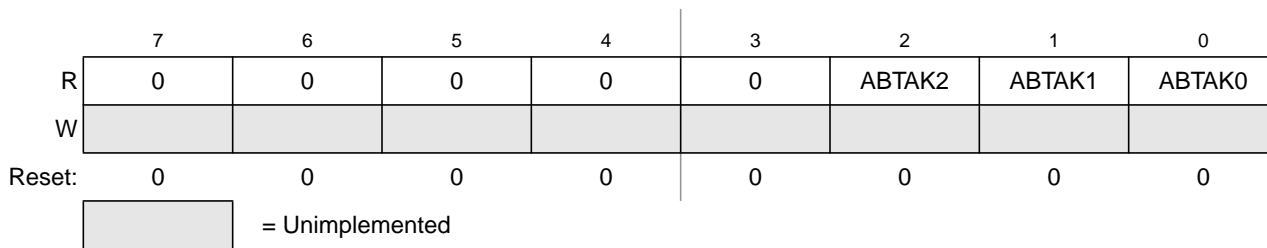
### 11.4.1.9 Clock Stretching

The clock synchronization mechanism can be used by slaves to slow down the bit rate of a transfer. After the master has driven SCL low the slave can drive SCL low for the required period and then release it. If the slave SCL low period is greater than the master SCL low period then the resulting SCL bus signal low period is stretched.



### 12.3.9 MSCAN Transmitter Message Abort Acknowledge Register (CANTAAK)

The CANTAAK register indicates the successful abort of messages queued for transmission, if requested by the appropriate bits in the CANTARQ register.



**Figure 12-13. MSCAN Transmitter Message Abort Acknowledge Register (CANTAAK)**

#### NOTE

The CANTAAK register is held in the reset state when the initialization mode is active (INTRQ = 1 and INITAK = 1).

Read: Anytime

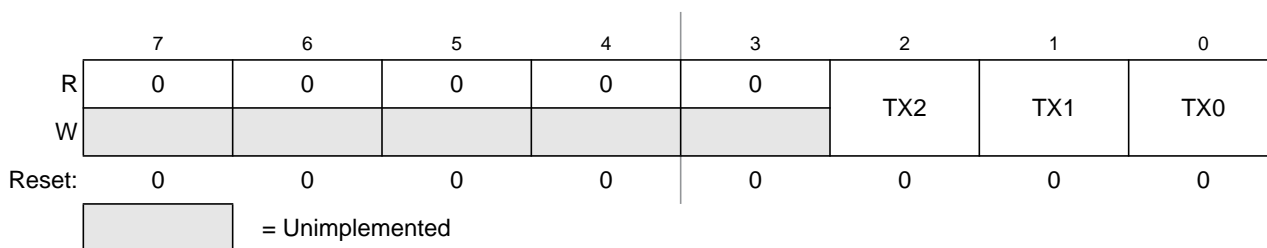
Write: Unimplemented for ABTAKx flags

**Table 12-14. CANTAAK Register Field Descriptions**

Field	Description
2:0 ABTAK[2:0]	<p><b>Abort Acknowledge</b> — This flag acknowledges that a message was aborted due to a pending transmission abort request from the CPU. After a particular message buffer is flagged empty, this flag can be used by the application software to identify whether the message was aborted successfully or was sent anyway. The ABTAKx flag is cleared whenever the corresponding TXE flag is cleared.</p> <p>0 The message was not aborted. 1 The message was aborted.</p>

### 12.3.10 MSCAN Transmit Buffer Selection Register (CANTBSEL)

The CANTBSEL selections of the actual transmit message buffer, which is accessible in the CANTXFG register space.



**Figure 12-14. MSCAN Transmit Buffer Selection Register (CANTBSEL)**

Section 12.3.4.1, “MSCAN Receiver Flag Register (CANRFLG)” and Section 12.3.5, “MSCAN Receiver Interrupt Enable Register (CANRIER”).

### 12.5.7.6 Interrupt Acknowledge

Interrupts are directly associated with one or more status flags in either the Section 12.3.4.1, “MSCAN Receiver Flag Register (CANRFLG)” or the Section 12.3.6, “MSCAN Transmitter Flag Register (CANTFLG).” Interrupts are pending as long as one of the corresponding flags is set. The flags in CANRFLG and CANTFLG must be reset within the interrupt handler to handshake the interrupt. The flags are reset by writing a 1 to the corresponding bit position. A flag cannot be cleared if the respective condition prevails.

#### NOTE

It must be guaranteed that the CPU clears only the bit causing the current interrupt. For this reason, bit manipulation instructions (BSET) must not be used to clear interrupt flags. These instructions may cause accidental clearing of interrupt flags which are set after entering the current interrupt service routine.

### 12.5.7.7 Recovery from Stop or Wait

The MSCAN can recover from stop or wait via the wake-up interrupt. This interrupt can only occur if the MSCAN was in sleep mode (SLPRQ = 1 and SLPK = 1) before entering power down mode, the wake-up option is enabled (WUPE = 1), and the wake-up interrupt is enabled (WUPIE = 1).

## 12.6 Initialization/Application Information

### 12.6.1 MSCAN initialization

The procedure to initially start up the MSCAN module out of reset is as follows:

1. Assert CANE
2. Write to the configuration registers in initialization mode
3. Clear INTRQ to leave initialization mode and enter normal mode

If the configuration of registers which are writable in initialization mode needs to be changed only when the MSCAN module is in normal mode:

1. Bring the module into sleep mode by setting SLPRQ and awaiting SLPK to assert after the CAN bus becomes idle.
2. Enter initialization mode: assert INTRQ and await INITAK
3. Write to the configuration registers in initialization mode
4. Clear INTRQ to leave initialization mode and continue in normal mode

## Chapter 13

# Serial Peripheral Interface (S08SPIV3)

### 13.1 Introduction

The serial peripheral interface (SPI) module provides for full-duplex, synchronous, serial communication between the MCU and peripheral devices. These peripheral devices can include other microcontrollers, analog-to-digital converters, shift registers, sensors, memories, etc.

The SPI runs at a baud rate up to the bus clock divided by two in master mode and bus clock divided by four in slave mode.

All devices in the MC9S08DV60 Series MCUs contain one SPI module, as shown in the following block diagram.

#### NOTE

Ensure that the SPI should not be disabled ( $SPE=0$ ) at the same time as a bit change to the CPHA bit. These changes should be performed as separate operations or unexpected behavior may occur.



## 13.5 Functional Description

An SPI transfer is initiated by checking for the SPI transmit buffer empty flag (SPTEF = 1) and then writing a byte of data to the SPI data register (SPID) in the master SPI device. When the SPI shift register is available, this byte of data is moved from the transmit data buffer to the shifter, SPTEF is set to indicate there is room in the buffer to queue another transmit character if desired, and the SPI serial transfer starts.

During the SPI transfer, data is sampled (read) on the MISO pin at one SPSCCK edge and shifted, changing the bit value on the MOSI pin, one-half SPSCCK cycle later. After eight SPSCCK cycles, the data that was in the shift register of the master has been shifted out the MOSI pin to the slave while eight bits of data were shifted in the MISO pin into the master's shift register. At the end of this transfer, the received data byte is moved from the shifter into the receive data buffer and SPRF is set to indicate the data can be read by reading SPID. If another byte of data is waiting in the transmit buffer at the end of a transfer, it is moved into the shifter, SPTEF is set, and a new transfer is started.

Normally, SPI data is transferred most significant bit (MSB) first. If the least significant bit first enable (LSBFE) bit is set, SPI data is shifted LSB first.

When the SPI is configured as a slave, its  $\overline{SS}$  pin must be driven low before a transfer starts and  $\overline{SS}$  must stay low throughout the transfer. If a clock format where CPHA = 0 is selected,  $\overline{SS}$  must be driven to a logic 1 between successive transfers. If CPHA = 1,  $\overline{SS}$  may remain low between successive transfers. See [Section 13.5.1, "SPI Clock Formats"](#) for more details.

Because the transmitter and receiver are double buffered, a second byte, in addition to the byte currently being shifted out, can be queued into the transmit data buffer, and a previously received character can be in the receive data buffer while a new character is being shifted in. The SPTEF flag indicates when the transmit buffer has room for a new character. The SPRF flag indicates when a received character is available in the receive data buffer. The received character must be read out of the receive buffer (read SPID) before the next transfer is finished or a receive overrun error results.

In the case of a receive overrun, the new data is lost because the receive buffer still held the previous character and was not ready to accept the new data. There is no indication for such an overrun condition so the application system designer must ensure that previous data has been read from the receive buffer before a new transfer is initiated.

### 13.5.1 SPI Clock Formats

To accommodate a wide variety of synchronous serial peripherals from different manufacturers, the SPI system has a clock polarity (CPOL) bit and a clock phase (CPHA) control bit to select one of four clock formats for data transfers. CPOL selectively inserts an inverter in series with the clock. CPHA chooses between two different clock phase relationships between the clock and data.

[Figure 13-10](#) shows the clock formats when CPHA = 1. At the top of the figure, the eight bit times are shown for reference with bit 1 starting at the first SPSCCK edge and bit 8 ending one-half SPSCCK cycle after the sixteenth SPSCCK edge. The MSB first and LSB first lines show the order of SPI data bits depending on the setting in LSBFE. Both variations of SPSCCK polarity are shown, but only one of these waveforms applies for a specific transfer, depending on the value in CPOL. The SAMPLE IN waveform applies to the MOSI input of a slave or the MISO input of a master. The MOSI waveform applies to the MOSI output

## 17.3 On-Chip Debug System (DBG)

Because HCS08 devices do not have external address and data buses, the most important functions of an in-circuit emulator have been built onto the chip with the MCU. The debug system consists of an 8-stage FIFO that can store address or data bus information, and a flexible trigger system to decide when to capture bus information and what information to capture. The system relies on the single-wire background debug system to access debug control registers and to read results out of the eight stage FIFO.

The debug module includes control and status registers that are accessible in the user's memory map. These registers are located in the high register space to avoid using valuable direct page memory space.

Most of the debug module's functions are used during development, and user programs rarely access any of the control and status registers for the debug module. The one exception is that the debug system can provide the means to implement a form of ROM patching. This topic is discussed in greater detail in [Section 17.3.6, "Hardware Breakpoints."](#)

### 17.3.1 Comparators A and B

Two 16-bit comparators (A and B) can optionally be qualified with the R/W signal and an opcode tracking circuit. Separate control bits allow you to ignore R/W for each comparator. The opcode tracking circuitry optionally allows you to specify that a trigger will occur only if the opcode at the specified address is actually executed as opposed to only being read from memory into the instruction queue. The comparators are also capable of magnitude comparisons to support the inside range and outside range trigger modes. Comparators are disabled temporarily during all BDC accesses.

The A comparator is always associated with the 16-bit CPU address. The B comparator compares to the CPU address or the 8-bit CPU data bus, depending on the trigger mode selected. Because the CPU data bus is separated into a read data bus and a write data bus, the RWAEN and RWA control bits have an additional purpose, in full address plus data comparisons they are used to decide which of these buses to use in the comparator B data bus comparisons. If RWAEN = 1 (enabled) and RWA = 0 (write), the CPU's write data bus is used. Otherwise, the CPU's read data bus is used.

The currently selected trigger mode determines what the debugger logic does when a comparator detects a qualified match condition. A match can cause:

- Generation of a breakpoint to the CPU
- Storage of data bus values into the FIFO
- Starting to store change-of-flow addresses into the FIFO (begin type trace)
- Stopping the storage of change-of-flow addresses into the FIFO (end type trace)

### 17.3.2 Bus Capture Information and FIFO Operation

The usual way to use the FIFO is to setup the trigger mode and other control options, then arm the debugger. When the FIFO has filled or the debugger has stopped storing data into the FIFO, you would read the information out of it in the order it was stored into the FIFO. Status bits indicate the number of words of valid information that are in the FIFO as data is stored into it. If a trace run is manually halted by writing 0 to ARM before the FIFO is full (CNT = 1:0:0:0), the information is shifted by one position and

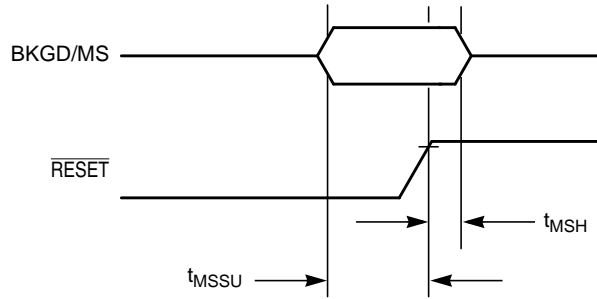


Figure A-3. Active Background Debug Mode Latch Timing

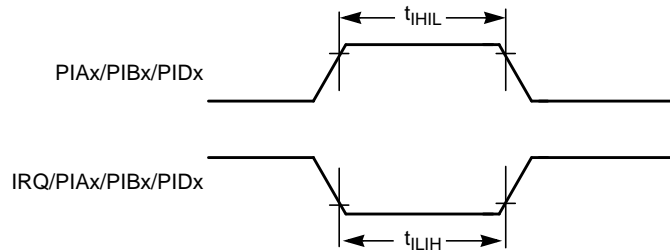


Figure A-4. Pin Interrupt Timing

### A.12.2 Timer/PWM

Synchronizer circuits determine the shortest input pulses that can be recognized or the fastest clock that can be used as the optional external source to the timer counter. These synchronizers operate from the current bus rate clock.

Table A-14. TPM Input Timing

Num	C	Rating	Symbol	Min	Max	Unit
1	—	External clock frequency	$f_{TCLK}$	dc	$f_{Bus}/4$	MHz
2	—	External clock period	$t_{TCLK}$	4	—	$t_{cyc}$
3	D	External clock high time	$t_{clkh}$	1.5	—	$t_{cyc}$
4	D	External clock low time	$t_{clkl}$	1.5	—	$t_{cyc}$
5	D	Input capture pulse width	$t_{ICPW}$	1.5	—	$t_{cyc}$

## A.12.4 SPI

Table A-16 and Figure A-7 through Figure A-10 describe the timing requirements for the SPI system.

**Table A-16. SPI Electrical Characteristic**

Num <sup>1</sup>	C	Rating <sup>2</sup>	Symbol	Min	Max	Unit	
1	D	Cycle time	Master	$t_{SCK}$	2	2048	$t_{cyc}$
			Slave	$t_{SCK}$	4	—	$t_{cyc}$
2	D	Enable lead time	Master	$t_{Lead}$	—	1/2	$t_{SCK}$
			Slave	$t_{Lead}$	1/2	—	$t_{SCK}$
3	D	Enable lag time	Master	$t_{Lag}$	—	1/2	$t_{SCK}$
			Slave	$t_{Lag}$	1/2	—	$t_{SCK}$
4	D	Clock (SPSCK) high time Master and Slave	$t_{SCKH}$	$(1/2 t_{SCK}) - 25$	—	ns	
5	D	Clock (SPSCK) low time Master and Slave	$t_{SCKL}$	$(1/2 t_{SCK}) - 25$	—	ns	
6	D	Data setup time (inputs)	Master	$t_{SI(M)}$	30	—	ns
			Slave	$t_{SI(S)}$	30	—	ns
7	D	Data hold time (inputs)	Master	$t_{HI(M)}$	30	—	ns
			Slave	$t_{HI(S)}$	30	—	ns
8	D	Access time, slave <sup>3</sup>	$t_A$	0	40	ns	
9	D	Disable time, slave <sup>4</sup>	$t_{dis}$	—	40	ns	
10	D	Data setup time (outputs)	Master	$t_{SO}$	25	—	ns
			Slave	$t_{SO}$	25	—	ns
11	D	Data hold time (outputs)	Master	$t_{HO}$	-10	—	ns
			Slave	$t_{HO}$	-10	—	ns
12	D	Operating frequency <sup>5</sup>	Master	$f_{op}$	$f_{Bus}/2048$	5	MHz
			Slave	$f_{op}$	dc	$f_{Bus}/4$	

<sup>1</sup> Refer to Figure A-7 through Figure A-10.

<sup>2</sup> All timing is shown with respect to 20%  $V_{DD}$  and 70%  $V_{DD}$ , unless noted; 100 pF load on all SPI pins. All timing assumes slew rate control disabled and high drive strength enabled for SPI output pins.

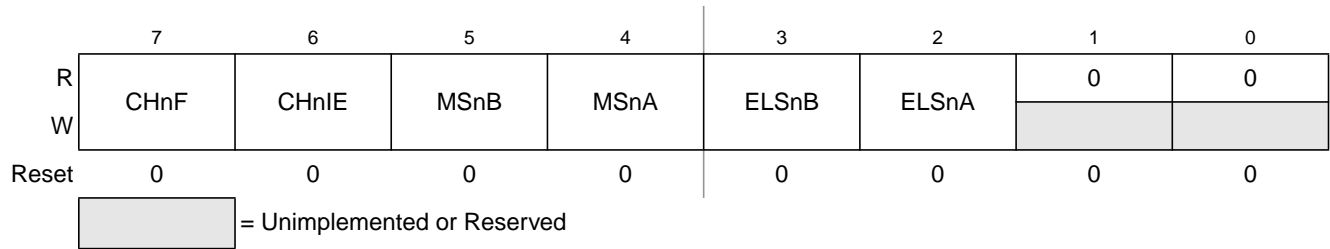
<sup>3</sup> Time to data active from high-impedance state.

<sup>4</sup> Hold time to high-impedance state.

<sup>5</sup> Maximum baud rate must be limited to 5 MHz due to pad input characteristics.

## B.2.4 Timer Channel n Status and Control Register (TPMxCnSC)

TPMxCnSC contains the channel interrupt status flag and control bits that are used to configure the interrupt enable, channel configuration, and pin function.



**Figure B-7. Timer Channel n Status and Control Register (TPMxCnSC)**

**Table B-4. TPMxCnSC Register Field Descriptions**

Field	Description
7 CHnF	<p><b>Channel n Flag</b> — When channel n is configured for input capture, this flag bit is set when an active edge occurs on the channel n pin. When channel n is an output compare or edge-aligned PWM channel, CHnF is set when the value in the TPM counter registers matches the value in the TPM channel n value registers. This flag is seldom used with center-aligned PWMs because it is set every time the counter matches the channel value register, which correspond to both edges of the active duty cycle period.</p> <p>A corresponding interrupt is requested when CHnF is set and interrupts are enabled (CHnIE = 1). Clear CHnF by reading TPMxCnSC while CHnF is set and then writing a 0 to CHnF. If another interrupt request occurs before the clearing sequence is complete, the sequence is reset so CHnF would remain set after the clear sequence was completed for the earlier CHnF. This is done so a CHnF interrupt request cannot be lost by clearing a previous CHnF. Reset clears CHnF. Writing a 1 to CHnF has no effect.</p> <p>0 No input capture or output compare event occurred on channel n 1 Input capture or output compare event occurred on channel n</p>
6 CHnIE	<p><b>Channel n Interrupt Enable</b> — This read/write bit enables interrupts from channel n. Reset clears CHnIE.</p> <p>0 Channel n interrupt requests disabled (use software polling) 1 Channel n interrupt requests enabled</p>
5 MSnB	<p><b>Mode Select B for TPM Channel n</b> — When CPWMS = 0, MSnB = 1 configures TPM channel n for edge-aligned PWM mode. For a summary of channel mode and setup controls, refer to <a href="#">Table B-5</a>.</p>
4 MSnA	<p><b>Mode Select A for TPM Channel n</b> — When CPWMS = 0 and MSnB = 0, MSnA configures TPM channel n for input capture mode or output compare mode. Refer to <a href="#">Table B-5</a> for a summary of channel mode and setup controls.</p>
3:2 ELSn[B:A]	<p><b>Edge/Level Select Bits</b> — Depending on the operating mode for the timer channel as set by CPWMS:MSnB:MSnA and shown in <a href="#">Table B-5</a>, these bits select the polarity of the input edge that triggers an input capture event, select the level that will be driven in response to an output compare match, or select the polarity of the PWM output.</p> <p>Setting ELSnB:ELSnA to 0:0 configures the related timer pin as a general-purpose I/O pin unrelated to any timer channel functions. This function is typically used to temporarily disable an input capture channel or to make the timer pin available as a general-purpose I/O pin when the associated timer channel is set up as a software timer that does not require the use of a pin.</p>